

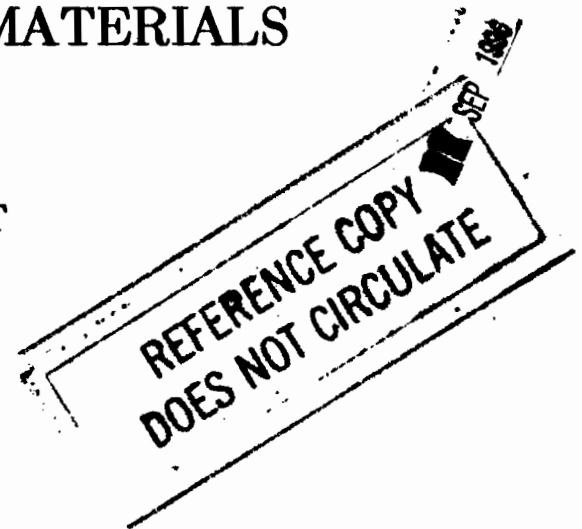

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MEMORANDUM REPORT BRL-MR-3569

**ADIABATIC SHEAR BANDS IN SIMPLE
AND DIPOLAR PLASTIC MATERIALS**

**THOMAS W. WRIGHT
ROMESH C. BATRA**

MARCH 1987



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I. INTRODUCTION

Adiabatic shear is the name given to a localization phenomenon that occurs during high rate plastic deformation such as machining, explosive forming, shock impact loading, or ballistic penetration. The process is usually described as being initiated by thermal softening in competition with rate effects and work hardening. Heat generated by plastic work softens the material so that eventually stress falls with increasing strain. When that occurs, the material becomes unstable locally and tends to accumulate essentially all of any additional imposed strain in a narrow band. In turn the local heating increases, and the process is driven further. As the localization intensifies, substantial gradients of temperature build up so that in the later stages of development heat flows out of the band thus tending to offset the thermal buildup in the band.

In two previous papers Wright and Batra^{1,2} have described the results of computations that simulate the formation of a single shear band from a local temperature inhomogeneity in a simple material. Strain gradients in the calculations reach approximately 0.2 per μm , and experimental evidence³ indicates gradients that ultimately are orders of magnitude larger. Therefore, it has seemed worthwhile to reformulate the theory to include gradient effects. This has been accomplished by modifying the dipolar theory due to Green, McInnis, and Naghdi⁴ to include a rate effect.

II. FORMULATION OF THE PROBLEM

In order to concentrate on fundamentals, the process has been idealized as one dimensional shearing of a finite block of material. Accordingly the three dimensional theory of Green, et al⁴ is summarized here for one dimension. In addition, the yield function is taken to depend on the plastic parts of strain rate and gradient of strain rate as well as the usual variables.

A one dimensional shearing motion can be expressed as

$$x = X + u(Y, t), \quad y = Y, \quad z = Z \quad \text{for } -H \leq Y \leq +H \quad (1)$$

If it is supposed that on any fixed surface Y is constant, surface tractions, τ , do work against the velocity, $\dot{x}$, and hypertractions, σ , do work against the velocity gradient, $\dot{x}_{,Y}$, then the one dimensional expressions for balance of linear momentum, energy, and entropy may be written as equations (2).

$$\tau_{,Y} + \hat{\rho} b = \rho \ddot{x}$$

$$\rho \dot{U} = \tau \dot{x}_{,Y} + (\sigma \dot{x}_{,Y}),_Y - q_{,Y} + \rho (\hat{c} \dot{x}_{,Y} + r) \quad (2)$$

$$\rho T \dot{\eta} - \frac{q}{T} T_{,Y} + q_{,Y} - \rho r \geq 0$$

In these equations $\hat{b}$ and $\hat{c}$ are the simple and dipolar body forces respectively, U is the internal energy, q is heat flux, r is the volumetric supply of energy, T is temperature, η is specific entropy, and ρ is mass density, which is constant. The superimposed dot and the comma followed by Y indicate differentiation with respect to time t and the material coordinate, Y , respectively. Following Green, et al,⁴ it will be convenient to define another stress by the equation

$$s \equiv \tau + \sigma_{,Y} + \rho \hat{c} \quad (3)$$

Equations (2) hold for any dipolar material, either elastic or plastic, for motions of the type given by (1).

Now define shear strain and shear strain gradient by

$$\gamma \equiv x_{,Y} \quad d \equiv \gamma_{,Y} = x_{,YY}$$

and suppose that these can both be decomposed into elastic and plastic parts.

$$\gamma = \gamma_e + \gamma_p, \quad d = d_e + d_p \quad (4)$$

None of γ_e , γ_p , d_e or d_p are necessarily gradients, but of course their sums γ and d must be the gradients of x and γ , respectively. Next let κ be a measure of plastic work hardening. Finally, in the same spirit as classical plasticity, a scalar yield or loading function f is assumed to exist, but here it is taken to depend on plastic strain rates, as well as stresses and temperature,

$$f(s, \sigma, T, \dot{\gamma}_p, \dot{d}_p) = \kappa \quad (5)$$

In general this and other plastic constitutive functions could depend on elastic and plastic strains as well, but that possibility will be ignored in this paper unless explicitly stated otherwise.

The static yield surface is given by (5) with $\dot{\gamma}_p = \dot{d}_p = 0$, and for quasi-static deformations a continuity argument for neutral loading, as advanced in Ref. 4 leads to the following reduced forms for the plastic rates.

$$\dot{\gamma}_p = \Lambda \alpha, \quad \dot{d}_p = \Lambda \beta \quad (6)$$

where α and β are constitutive functions that depend only on s , σ , T , and κ .

The multiplier Λ is proportional to $\hat{f} = f_s \dot{s} + f_\sigma \dot{\sigma} + f_T \dot{T}$, where the subscripts

denote partial differentiation with respect to the arguments, and $\dot{\gamma}_p = \dot{d}_p = 0$ in evaluating the derivatives of f .

Now let it be assumed that (6) holds even when $\dot{\gamma}_p \neq 0$, $\dot{d}_p \neq 0$, so that in the general case (5) becomes

$$f(s, \sigma, T, \Lambda\alpha(s, \sigma, T, \kappa), \Lambda\beta(s, \sigma, T, \kappa)) = \kappa \quad (7)$$

and the criterion for elastic or plastic loading is simply

$$\begin{aligned} f(s, \sigma, T, 0, 0) &\leq \kappa, \text{ elastic;} \\ f(s, \sigma, T, 0, 0) &> \kappa, \text{ plastic.} \end{aligned} \quad (8)$$

To make sense the derivative f_Λ , obtained from (7) must be negative for all values of the other arguments. Then if plastic flow is occurring according to (8), Λ may be found from inversion of (7), and because of the assumed monotonicity of f with respect to Λ , there will always be a unique solution with $\Lambda > 0$. With the assumption that U, s, σ, T depend on the variables γ_e, d_e, η and that q depends on the same variables plus the gradient $T_{,Y}$, standard thermodynamic arguments give

$$T = \frac{\partial U}{\partial \eta}, \quad s = \rho \frac{\partial U}{\partial \gamma_e}, \quad \sigma = \rho \frac{\partial U}{\partial d_e} \quad (9)$$

The energy and entropy laws now reduce to

$$\rho T \dot{\eta} = s \dot{\gamma}_p + \sigma \dot{d}_p - q_{,Y} + \rho r, \quad s \dot{\gamma}_p + \sigma \dot{d}_p - \frac{q}{T} T_{,Y} \geq 0 \quad (10)$$

where $\dot{\gamma}_p = \dot{d}_p = 0$ during elastic deformation and $\neq 0$ during plastic deformation.

III. CONSTITUTIVE EQUATIONS AND NONDIMENSIONAL FORMS

For computational purposes simple constitutive equations have been chosen as follows:

$$\begin{aligned} \rho U &= \frac{1}{2} \mu \gamma_e^2 + \frac{1}{2} \ell^2 \mu d_e^2 + \rho T_0 c \left(e^{\frac{\eta - \eta_0}{c}} - 1 \right) \\ \dot{\kappa} &= \frac{h(\kappa)}{\kappa} (s \dot{\gamma}_p + \sigma \dot{d}_p), \quad q = -k T_{,Y} \end{aligned} \quad (11)$$

$$\alpha = s, \quad \beta = \frac{1}{\ell} \sigma \quad (11 \text{ cont.})$$

$$(s^2 + \frac{1}{\ell} \sigma^2)^{1/2} = \kappa \{1 - a(T - T_0)\} \{1 + b(\dot{\gamma}_p^2 + \ell^2 \dot{d}_p^2)^{1/2}\}^m.$$

In (11)₁ μ is the usual elastic shear modulus and ℓ is a characteristic material property with the dimensions of length, T_0 is a reference temperature, and c is specific heat. With this simple choice for the internal energy there is no thermoelastic effect and no thermal expansion. The stresses and the temperature follow from (9). In (11)₂ the function $h(\kappa)$ is the plastic slope of a reference isothermal shear test, which is chosen to be

$$h = \frac{n}{\psi_0} \kappa_0^{\frac{1}{n}} \kappa^{1 - \frac{1}{n}} \quad (12)$$

Here κ_0 is the initial yield stress, n is the work hardening exponent, and ψ_0 may be chosen to fit the initial slope of an empirical curve of stress versus plastic strain. Equation (11)₂ states that κ evolves according to the plastic work done no matter what the conditions of the test. Equation (11)₃ is Fourier's law and equations (11)₄ and (11)₅ have been chosen in a simple form that is dimensionally correct and leads to positive plastic work. Finally in (11)₆ the function f has been chosen to be made up of three multiplicative factors involving the stresses, the temperature, and the plastic rates, respectively. In (11)₆ a is the coefficient of thermal softening, b is a characteristic time, and m is the strain rate exponent. In general the value of ℓ could be different in each of the four places that it appears in (11), but such complexity is not warranted for the time being since there is no microscopic theory available for guidance.

In nondimensional form the full set of equations in the absence of body forces and supply of energy may be written as follows

$$\begin{aligned} \text{Momentum: } (s - \ell \sigma, \gamma), \gamma &= \rho v \\ \text{Energy: } \dot{\theta} &= k \theta, \gamma \gamma + s \dot{\gamma}_p + \ell \sigma \dot{d}_p \\ \text{Constitutive: } \dot{s} &= \mu(v, \gamma - \dot{\gamma}_p), \quad \dot{\gamma}_p = \Lambda s \end{aligned} \quad (13)$$

$$\dot{\sigma} = \ell \mu (v, \dot{\gamma} \dot{\gamma} - \dot{d}_p), \quad \dot{d}_p = \frac{\Lambda}{\bar{\ell}} \sigma$$

$$\dot{\kappa} = \frac{h(\kappa)}{\bar{\kappa}} (s \dot{\gamma}_p + \ell \sigma \dot{d}_p), \quad h = \frac{n}{\psi_0} \kappa^1 - \frac{1}{n}$$

(13 cont.)

$$\text{Yield: } (s^2 + \sigma^2)^{1/2} = (1 - a\theta) \{1 + b\Lambda(s^2 + \sigma^2)^{1/2}\}^m$$

$$\text{where } \Lambda > 0 \text{ only if } (s^2 + \sigma^2)^{1/2} > \kappa(1 - a\theta)$$

$$\Lambda = 0 \text{ otherwise}$$

In (13) the temperature T has been replaced by the temperature increase $\theta = T - T_0$. The nondimensional variables are related to their dimensional (barred) counterparts as follows:

$$Y = \bar{Y}/H, \quad t = \bar{t}\dot{\gamma}_0$$

$$v = \bar{v}/H\dot{\gamma}_0, \quad s = \bar{s}/\kappa_0, \quad \sigma = \bar{\sigma}/\bar{\ell}\kappa_0, \quad \theta = \bar{\theta}\bar{\rho}c/\kappa_0, \quad \kappa = \bar{\kappa}/\kappa_0 \quad (14)$$

$$\gamma = \bar{\gamma}, \quad d = \bar{d}H, \quad \dot{\gamma}_p = \dot{\bar{\gamma}}_p/\dot{\gamma}_0, \quad \dot{d}_p = \dot{\bar{d}}_p H/\dot{\gamma}_0, \quad \Lambda = \bar{\Lambda} \kappa_0/\dot{\gamma}_0$$

Besides m , n , and ψ_0 there are six other nondimensional parameters, which are related to their dimensional (barred) counterparts as follows:

$$a = \bar{a}\kappa_0/\bar{\rho}c, \quad b = \bar{b}\dot{\gamma}_0, \quad k = \bar{k}/\bar{\rho}c\dot{\gamma}_0 H^2, \quad \ell = \bar{\ell}/H$$

(15)

$$\mu = \bar{\mu}/\kappa_0, \quad \rho = \bar{\rho}H^2\dot{\gamma}_0^2/\kappa_0$$

In (14) and (15) $\dot{\gamma}_0 = \bar{v}(H, \bar{t})/H$ is the average applied strain rate between the boundaries $\bar{Y} = \pm H$.

IV. HOMOGENEOUS SOLUTIONS AND PERTURBATIONS

Equations (13) have homogeneous solutions with $v = Y$ and all other dependent variables independent of Y . With initial values taken to be $s(0) = \kappa(0) = 1$ and $\theta(0) = \sigma(0) = 0$, the solution for s , κ , and θ is exactly the same

as for a simple material (see Wright and Batra^{1,2}) and σ is identically zero. Figure 1 shows several curves for homogeneous solutions of equations (13) obtained for particular choices of the parameters. With $a = b = 0$ there is no thermal softening and no rate effect so the resulting curve is simply the slow, isothermal stress/strain curve, called the reference curve, from which the function $h(\cdot)$ was derived. With $a = 0$, but with a finite value for b , the curve shows the isothermal response at a high rate of deformation. With finite values for both a and b the curve shows the adiabatic response at a high rate of deformation. The nondimensional parameters chosen here are the same as those listed in Ref. 2 namely

$$\begin{array}{llll} \rho = 3.928 \times 10^{-5} & k = 3.978 \times 10^{-3} & a = 0.4973 & \mu = 240.3 \\ n = 0.09 & \psi_0 = 0.017 & b = 5 \times 10^6 & m = 0.025 \end{array}$$

The value for ℓ is immaterial for the homogeneous response as are ρ and k . The adiabatic response curve is typical. Initially the stress rises elastically above the reference curve, but as the overstress increases, plastic straining sets in, the temperature rises, and the response softens relative to the isothermal response. Eventually thermal softening wins over work and rate hardening, so that the stress passes through a maximum (indicated by P in the figure) and then decreases with further deformation. The general character of the homogeneous response is well understood and has been reported many times in the literature, although the way the response changes with the various parameters depends on the particular model used for the thermo/viscoplasticity.

Once peak stress has been passed the material becomes extremely sensitive to inhomogeneities, and the deformation has a strong tendency to localize. To examine this behavior for a dipolar material and to compare the results to previous calculations for a simple material, calculations have been made for the response following a small temperature perturbation. At the point marked I in Figure 1 the computed homogeneous response was modified by adding a smooth temperature bump (height 0.1 and width 0.5) to the basic homogeneous response. After recalculating s so that the yield condition in (13) is still satisfied with the new temperature distribution, the problem was restarted as a new initial-boundary value problem with all other initial values as calculated previously and with boundary values at $Y = +1, 0$ taken to be $v = 1, 0$ and $\sigma = 0, \psi_Y = 0, 0$. With these boundary values, the average strain rate in the strip is the same as in the homogeneous calculation and the material remains adiabatic overall. The same approach was used in Refs. 1 and 2 for a simple material, but now the new material parameter ℓ is nonzero. Computations have been made for $\ell = 0, 10^{-4}$ and 10^{-2} . After casting the equations into a weak form, solutions were found using the finite element method for spatial discretization and an implicit Crank-Nicolson scheme to march forward in time. Previously a forward difference method was used for the time integration^{1,2}, but the step size was necessarily very small for the dipolar case.

Typical results are shown in Figures 2, 3, 4 and 5. Figure 2 shows the plastic strain rate in the center of the band as a function of the average applied strain. The nondimensionalization is such that increments of time are

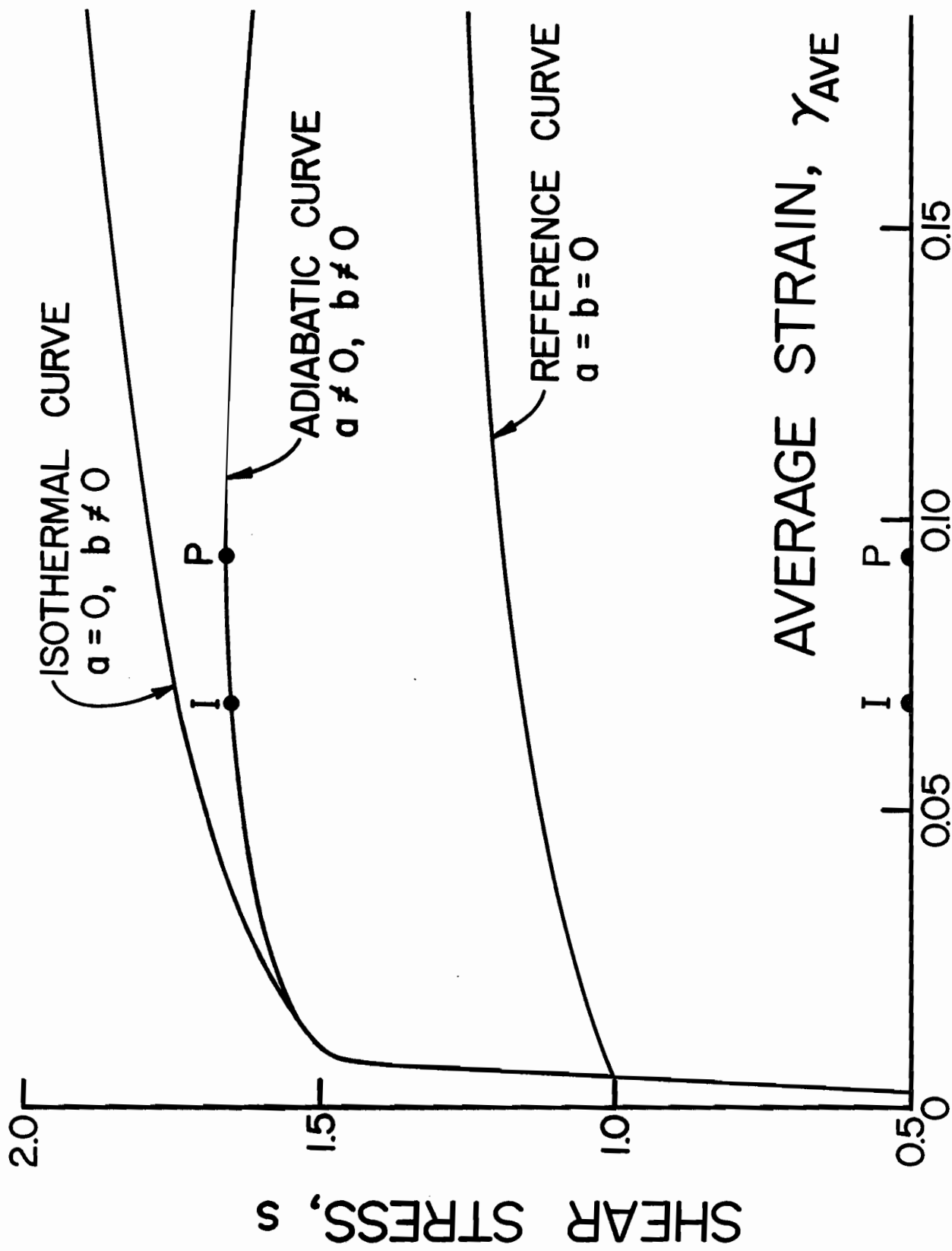


Figure 1. Typical reference, isothermal, and adiabatic response curves.

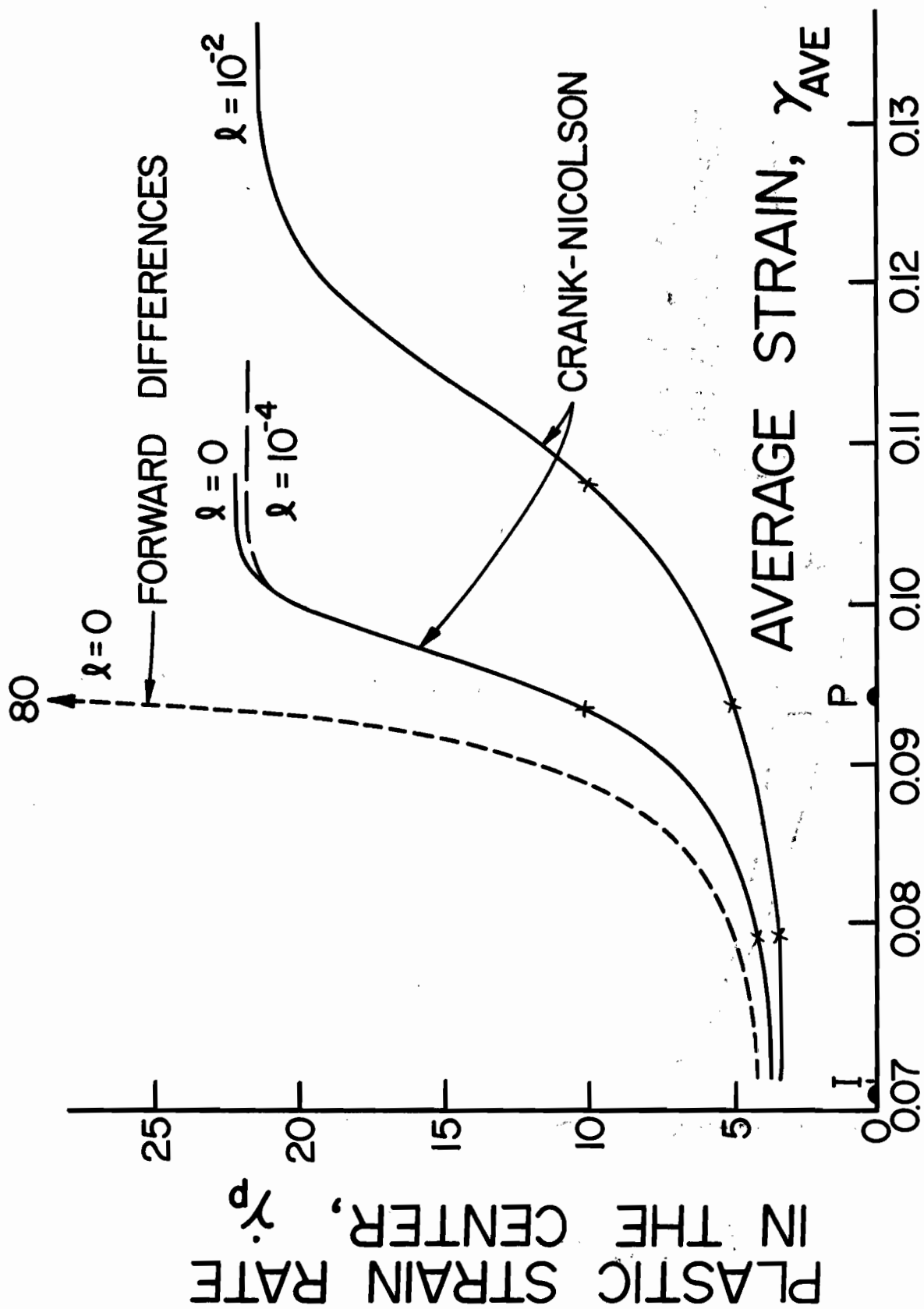


Figure 2. Plastic strain rate in the center of the band with a temperature perturbation.

exactly equal to increments of the average applied strain, so the curve may be interpreted equally well as a time plot. After a brief interval during which the field variables regain their essential balance, the central plastic strain rate begins a slow but accelerating climb. Eventually it turns up rather sharply for $\ell = 0$ or 10^{-4} and somewhat less sharply for $\ell = 10^{-2}$, the first two cases being virtually indistinguishable. Also, shown is the result from previous calculations² with $\ell = 0$, where the strain rate increases even more dramatically. The delay in the response for the present case relative to the previous one with $\ell = 0$ is probably due to a nonphysical damping, which is introduced by the Crank-Nicolson scheme as compared to the forward difference method. The result for $\ell = 10^{-2}$ relative to the other two cases shows the same stiffening effect due to the material length ℓ that was reported in Ref. 2. It is clear that the rate of increase of plastic strain rate can be substantially retarded if ℓ is large enough.

All cases calculated so far show the development of a late stage plateau, but the computed value is a numerical artifact and is not a physical result. Since $v = 1$ at the boundary $Y = 1$, it follows that

$$\int_0^1 \dot{\gamma} dY = \int_0^1 v_{,Y} dY = 1 \quad .$$

As shown in Figure 3, the plastic strain rate builds up in the center, but it decreases in the outer region. In the plateau region of the calculations, the plastic strain rate is nonzero at the center but falls to zero at $Y = 0.1$. With linear interpolation the nonzero part of the distribution is triangular, so the level of the plateau is effectively caused by the length scale that is introduced through the computational grid. In the previous results^{1,2} a more complicated interpolation scheme and a finer grid were used, which allowed the plateau to be delayed until the plastic rate reached approximately 80, as indicated in the figure. Although the level of the plateau is nonphysical, the fact that it is very likely fixed by the length scale of the grid suggest that one might expect a true plateau to develop where the level would be determined by the physical length scales of the problem. Two such physical lengths, one arising from thermal conductivity and one from viscous stress effects, were identified in Ref. 1 and the parameter ℓ is a possible third one. All three length scales may be very small and beyond convenient numerical resolution.

The cross plots of plastic strain rate at increasing values of average strain, as shown in Figure 3, are taken well before the plateau is reached, and so should be accurately representative of the progressive localization that occurs. The five crosses on the curves in Figure 2 correspond to the five curves in Figure 3. As the deformation continues, the plastic strain rate builds up in the center, but decreases in the outer regions. The relative stiffening of the dipolar material can be seen clearly in Figure 3 as well. For example, when the average strain reaches 0.093, the dipolar case with $\ell = 10^{-2}$ has reached only half the value for the cases $\ell = 0$ or 10^{-4} , and obviously continues to develop at a much slower rate. Since the peak in plastic strain rate is lower for larger values of ℓ , naturally the distribution is broader and the rate falls more slowly in the outer regions, as well.

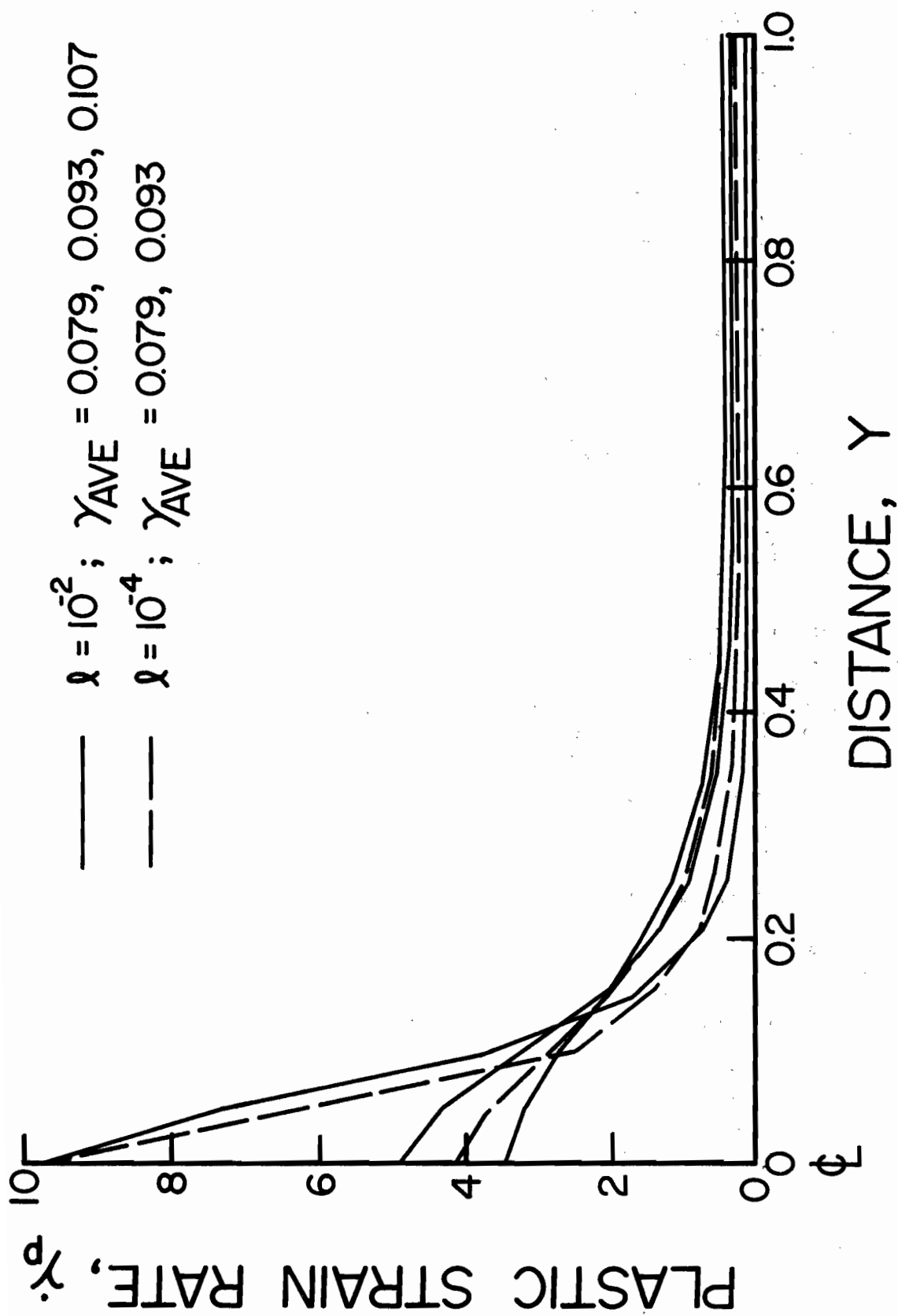


Figure 3. Cross plots of plastic strain for increasing deformation.

Temperature plots are not shown, but the results are similar to the previous calculations. At first the temperature follows the path of the homogeneous case quite closely, but as the deformation localizes so does the temperature distribution with a peak forming in the center and a plateau forming in the outer regions as the plastic heating falls to zero.

In all calculations so far the case for $\ell = 10^{-4}$ shows essentially no difference from the simple material. The reason for this is shown dramatically in Figure 4, which shows the dipolar stress distribution at several values of time. The assumed symmetry of the problem requires that the dipolar stress be an odd function of Y , and hence that it vanish at $Y = 0$. The peak of the distribution for $\ell = 10^{-2}$ lies near $Y = 0.2$ and moves somewhat toward the center for increasing time. The dipolar distribution for $\ell = 10^{-4}$ shows a similar shape, but now the peak value is only about 2% of the peak value for $\ell = 10^{-2}$ at the same time. For the smaller value of ℓ the dipolar effect is so weak that it has no effect on the calculations prior to the formation of the false plateau.

Figure 5 shows the computed values of shear stress as a function of average applied strain. At first the stress for each of the perturbed cases follows the homogeneous case quite closely, but eventually it deviates markedly. The stress remains nearly constant through the cross section at all times until the strain rate accelerates sharply upwards. Then the stress begins to fall, first in the center and then in the outer regions. The start of the drop in stress is clearly evident in the computed results, although in every case the curves have been drawn past the probable limit of validity (the tick mark on the curve). Here again the stiffening effect of the dipolar stress is evident in the delay and rate of departure from the homogeneous case. It is also interesting to note that even though the dipolar stress attains significant values, and the stiffening effect is clearly evident in the distribution of plastic strain, there is little difference between the shear stress s and the traction τ , as might have been expected from equation (3).

V. DISCUSSION AND CONCLUSIONS

In this paper a formulation has been given for shearing of thermo/viscoplastic dipolar material with heat conduction. Because of thermal softening, the stress at a point in the material may decrease with further straining, and so the material may tend to localize in the same manner as for a simple material. The dipolar, or gradient, effect has been added because large strain and temperature gradients form in the localized region. It has been found that this additional constitutive property has a stiffening effect relative to a simple material. That is, for the same perturbation the onset of localization is delayed and the rate of growth of the perturbation decreases with increasing dipolar strength. It has been found that the Crank-Nicolson scheme for stepping forward in time allows a much larger time step to be used than the simple forward difference method, but it also seems to introduce some artificial damping.

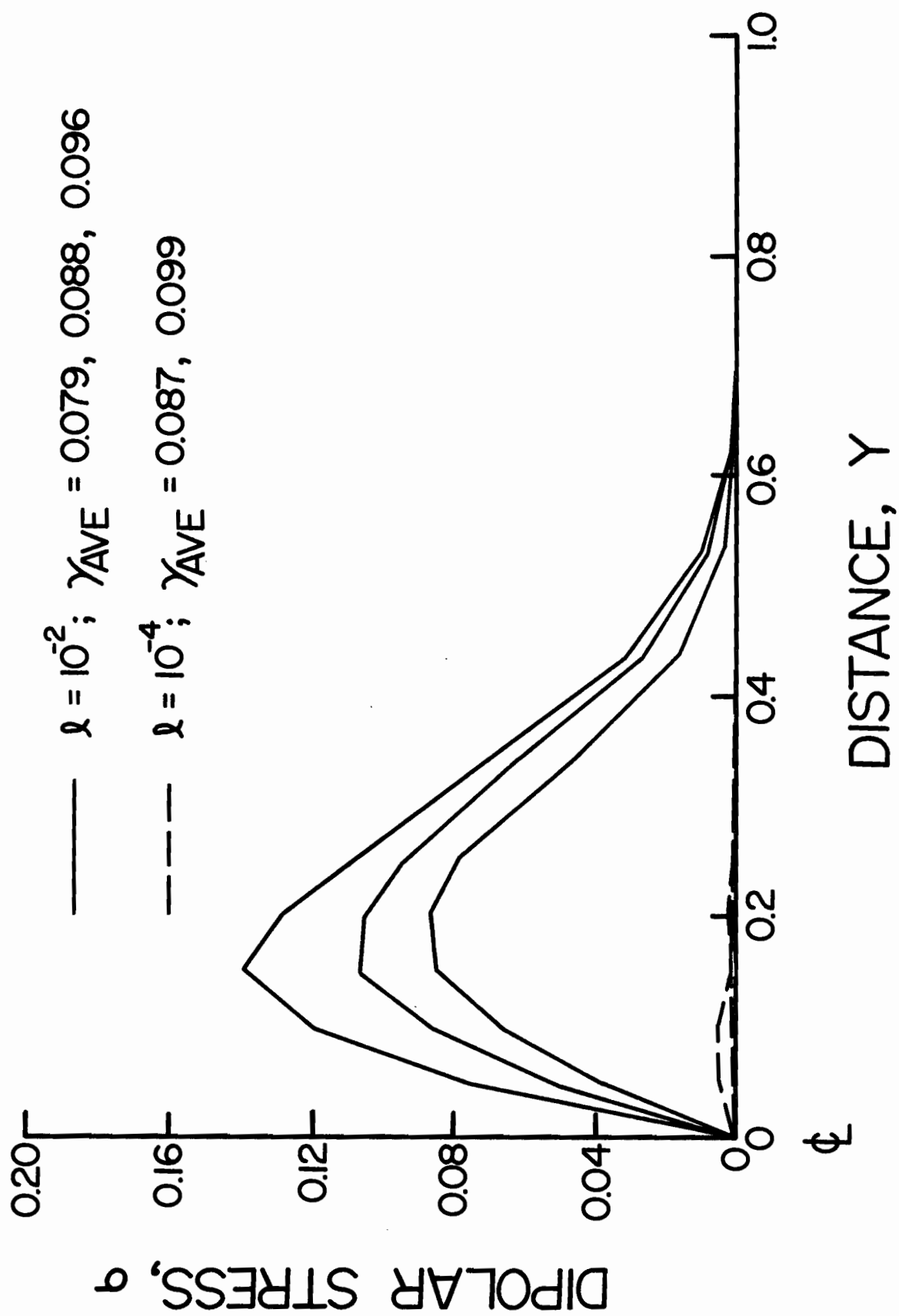


Figure 4. Cross plots of dipolar stress for increasing deformation.

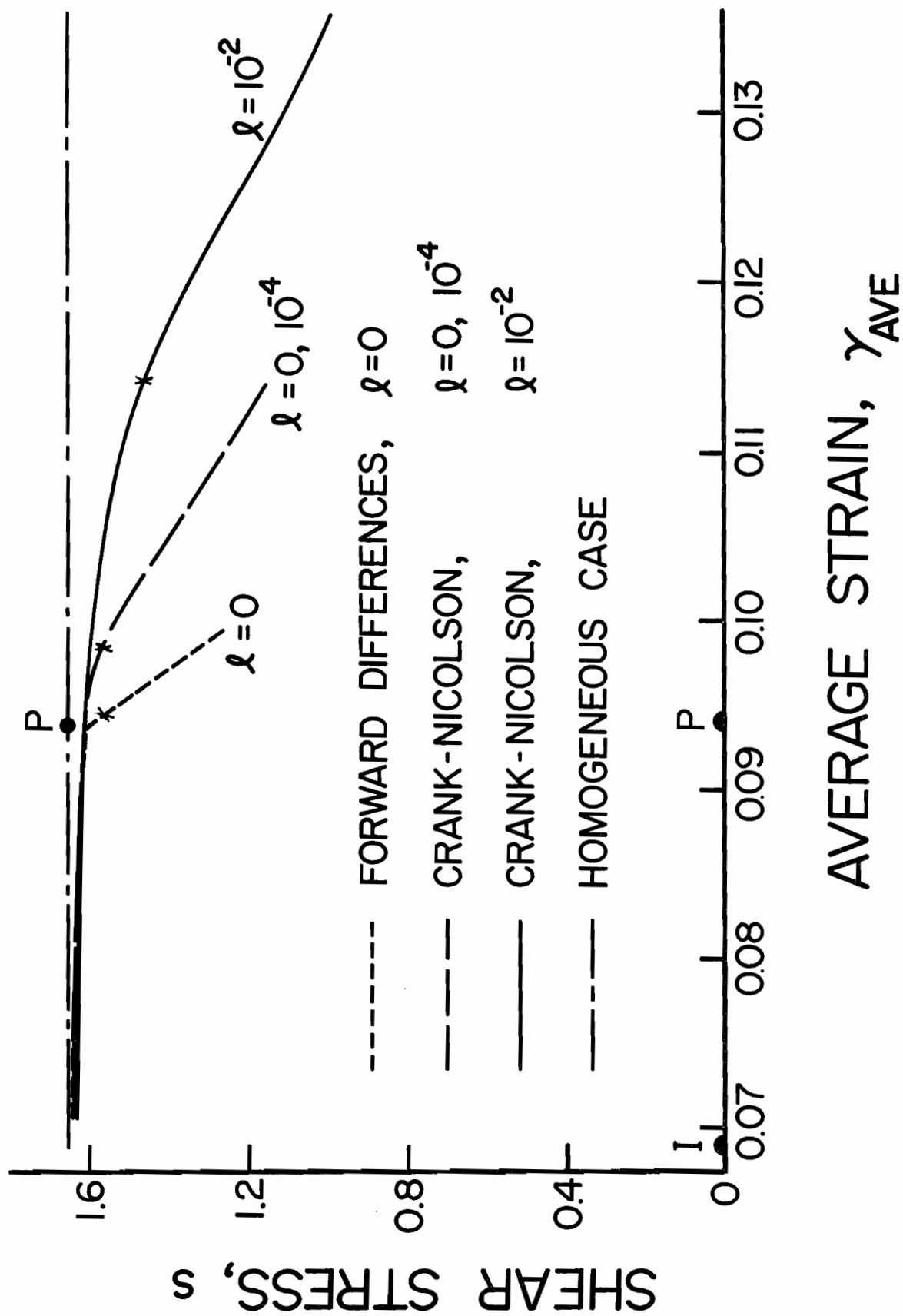


Figure 5. Stress in a shear band.

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